# 74LV4053

# Triple single-pole double-throw analog switch Rev. 5 — 18 September 2014

**Product data sheet** 

#### **General description** 1.

The 74LV4053 is a triple single-pole double-throw (SPDT) analog switch, suitable for use as an analog or digital multiplexer/demultiplexer. It is a low-voltage Si-gate CMOS device and is pin and function compatible with the 74HC4053 and 74HCT4053. Each switch has a digital select input (Sn), two independent inputs/outputs (nY0 and nY1) and a common input/output (nZ). All three switches share an enable input (E). A HIGH on E causes all switches into the high-impedance OFF-state, independent of Sn.

 $V_{CC}$  and GND are the supply voltage connections for the digital control inputs (Sn and  $\overline{E}$ ). The V<sub>CC</sub> to GND range is 1 V to 6 V. The analog inputs/outputs (nY0, nY1 and nZ) can swing between  $V_{CC}$  as a positive limit and  $V_{EE}$  as a negative limit.  $V_{CC} - V_{EE}$  may not exceed 6 V. For operation as a digital multiplexer/demultiplexer, V<sub>EE</sub> is connected to GND (typically ground). V<sub>EE</sub> and V<sub>SS</sub> are the supply voltage connections for the switches.

#### **Features and benefits** 2.

- Optimized for low-voltage applications: 1.0 V to 3.6 V
- Accepts TTL input levels between V<sub>CC</sub> = 2.7 V and V<sub>CC</sub> = 3.6 V
- Low ON resistance:
  - ♦ 180  $\Omega$  (typical) at  $V_{CC} V_{EE} = 2.0 \text{ V}$
  - ♦ 100  $\Omega$  (typical) at V<sub>CC</sub> V<sub>EE</sub> = 3.0 V
  - ♦ 75  $\Omega$  (typical) at V<sub>CC</sub> V<sub>EE</sub> = 4.5 V
- Logic level translation:
  - ◆ To enable 3 V logic to communicate with ±3 V analog signals
- Typical 'break before make' built in
- ESD protection:
  - HBM JESD22-A114-C exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



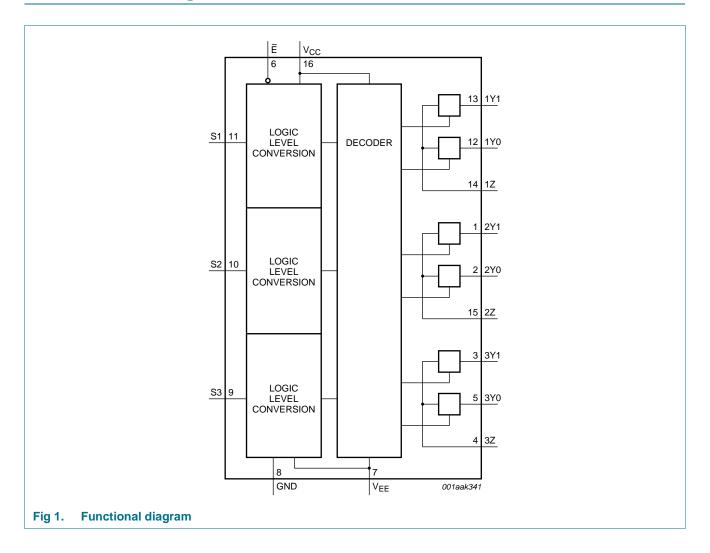
#### Triple single-pole double-throw analog switch

# 3. Ordering information

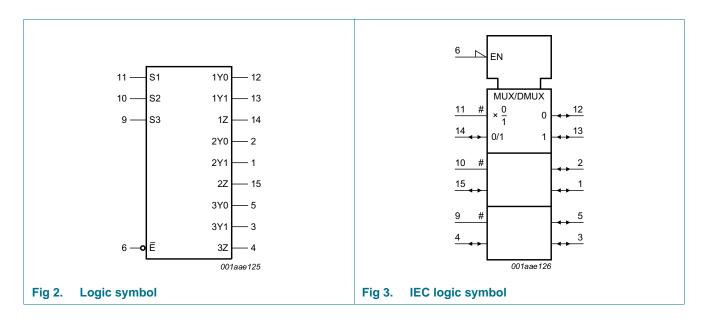
Table 1. Ordering information

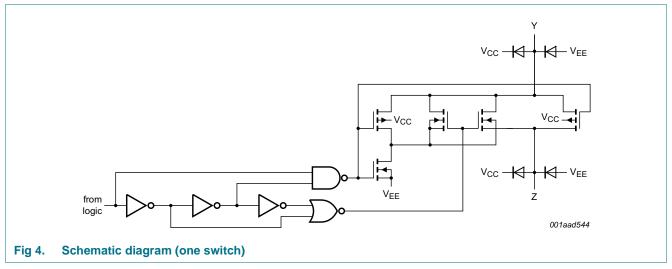
Type number	Package									
	Temperature range	Name	Description	Version						
74LV4053N	−40 °C to +125 °C	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4						
74LV4053D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1						
74LV4053DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1						
74LV4053PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1						
74LV4053BQ	-40 °C to +125 °C	DHVQFN16	plastic dual-in line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85$ mm	SOT763-1						

# 4. Functional diagram



#### Triple single-pole double-throw analog switch

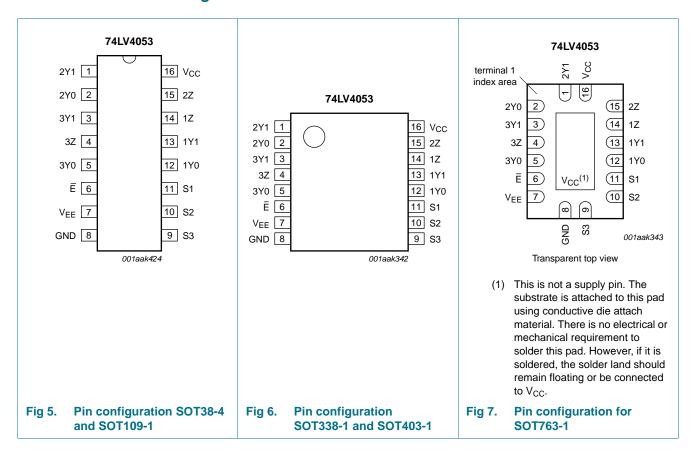




#### Triple single-pole double-throw analog switch

# 5. Pinning information

#### 5.1 Pinning



#### 5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
Ē	6	enable input (active LOW)
V <sub>EE</sub>	7	supply voltage
GND	8	ground supply voltage
S1, S2, S3	11, 10, 9	select input
1Y0, 2Y0, 3Y0	12, 2, 5	independent input or output
1Y1, 2Y1, 3Y1	13, 1, 3	independent input or output
1Z, 2Z, 3Z	14, 15, 4	common output or input
V <sub>CC</sub>	16	supply voltage

#### Triple single-pole double-throw analog switch

## 6. Functional description

#### Table 3. Function table [1]

Inputs	nputs			
E	Sn			
L	L	nY0 to nZ		
L	Н	nY1 to nZ		
Н	X	switches off		

<sup>[1]</sup> H = HIGH voltage level; L = LOW voltage level; X = don't care.

# 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to  $V_{SS} = 0 \text{ V (ground)}$ .

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage		[1]	-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	[2]	-	±20	mA
I <sub>SK</sub>	switch clamping current	$V_{SW} < -0.5 \text{ V or } V_{SW} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
I <sub>SW</sub>	switch current	$V_{SW} > -0.5 \text{ V or } V_{SW} < V_{CC} + 0.5 \text{ V};$ source or sink current	[2]	-	±25	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	[3]			
		DIP16 package		-	750	mW
		SO16 package		-	500	mW
		TSSOP16 package		-	500	mW
		DHVQFN16 package		-	500	mW

<sup>[1]</sup> To avoid drawing  $V_{CC}$  current out of terminal nZ, when switch current flows into terminals nYn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no  $V_{CC}$  current will flow out of terminals nYn, and in this case there is no limit for the voltage drop across the switch, but the voltages at nYn and nZ may not exceed  $V_{CC}$  or  $V_{EE}$ .

For DHVQFN16 packages: above 60 °C the value of  $P_{tot}$  derates linearly with 4.5 mW/K.

<sup>[2]</sup> The minimum input voltage rating may be exceeded if the input current rating is observed.

<sup>[3]</sup> For DIP16 packages: above 70  $^{\circ}$ C the value of P<sub>tot</sub> derates linearly with 12 mW/K.

For SO16 packages: above 70  $^{\circ}\text{C}$  the value of P  $_{\text{tot}}$  derates linearly with 8 mW/K.

For SSOP16 and TSSOP16 packages: above 60  $^{\circ}$ C the value of P<sub>tot</sub> derates linearly with 5.5 mW/K.

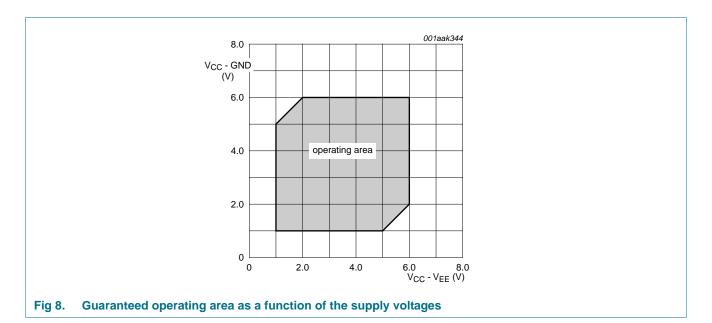
#### Triple single-pole double-throw analog switch

# 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage	see Figure 8	1	3.3	6	V
VI	input voltage		0	-	V <sub>CC</sub>	V
V <sub>SW</sub>	switch voltage		0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 1.0 V to 2.0 V	-	-	500	ns/V
		V <sub>CC</sub> = 2.0 V to 2.7 V	-	-	200	ns/V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	100	ns/V

<sup>[1]</sup> The static characteristics are guaranteed from  $V_{CC}$  = 1.2 V to 6.0 V, but LV devices are guaranteed to function down to  $V_{CC}$  = 1.0 V (with input levels GND or  $V_{CC}$ ).



#### Triple single-pole double-throw analog switch

# 9. Static characteristics

Table 6. Static characteristics

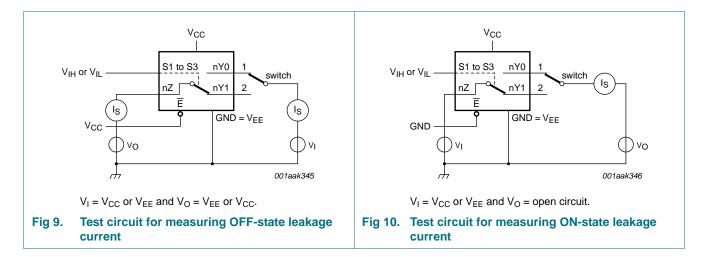
At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
$V_{IH}$	HIGH-level input voltage	V <sub>CC</sub> = 1.2 V	0.9	-	-	0.9	-	V
		V <sub>CC</sub> = 2.0 V	1.4	-	-	1.4	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
		V <sub>CC</sub> = 4.5 V	3.15	-	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.20	-	-	4.20	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 1.2 V	-	-	0.3	-	0.3	V
		V <sub>CC</sub> = 2.0 V	-	-	0.6	-	0.6	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V
		V <sub>CC</sub> = 4.5 V	-	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	-	1.80	-	1.80	V
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND						
		V <sub>CC</sub> = 3.6 V	-	-	1.0	-	1.0	μΑ
		V <sub>CC</sub> = 6.0 V	-	-	2.0	-	2.0	μΑ
I <sub>S(OFF)</sub>	OFF-state leakage current	$V_I = V_{IH}$ or $V_{IL}$ ; see Figure 9						
		V <sub>CC</sub> = 3.6 V	-	-	1.0	-	1.0	μΑ
		V <sub>CC</sub> = 6.0 V	-	-	2.0	-	2.0	μΑ
I <sub>S(ON)</sub>	ON-state leakage current	$V_I = V_{IH}$ or $V_{IL}$ ; see Figure 10						
		V <sub>CC</sub> = 3.6 V	-	-	1.0	-	1.0	μΑ
		V <sub>CC</sub> = 6.0 V	-	-	2.0	-	2.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A						
		V <sub>CC</sub> = 3.6 V	-	-	20	-	40	μΑ
		V <sub>CC</sub> = 6.0 V	-	-	40	-	80	μΑ
Δl <sub>CC</sub>	additional supply current	per input; $V_I = V_{CC} - 0.6 \text{ V}$ ; $V_{CC} = 2.7 \text{ V}$ to 3.6 V	-	-	500	-	850	μΑ
Cı	input capacitance		-	3.5	-	-	-	pF
C <sub>sw</sub>	switch capacitance	independent pins nYn	-	5	-	-	-	pF
		common pins nZ	-	8	-	-	-	pF

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C.

### Triple single-pole double-throw analog switch

#### 9.1 Test circuits



#### 9.2 ON resistance

Table 7. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see <u>Figure 11</u> and <u>Figure 12</u>.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
R <sub>ON(peak)</sub>	ON resistance (peak)	$V_I = 0 V \text{ to } V_{CC} - V_{EE}$							
		$V_{CC} = 1.2 \text{ V}; I_{SW} = 100 \mu\text{A}$		-	-	-	-	-	Ω
		$V_{CC} = 2.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	180	365	-	435	Ω
		$V_{CC} = 2.7 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	115	225	-	270	Ω
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V};$ $I_{SW} = 1000 \mu\text{A}$		-	100	200	-	245	Ω
		$V_{CC} = 4.5 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	75	150	-	180	Ω
		$V_{CC} = 6.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	70	140	-	165	Ω
$\Delta R_{ON}$	ON resistance mismatch	$V_I = 0 V \text{ to } V_{CC} - V_{EE}$							
	between channels	$V_{CC} = 1.2 \text{ V}; I_{SW} = 100 \mu\text{A}$	[2]	-	-	-	-	-	Ω
		$V_{CC} = 2.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	5	-	-	-	Ω
		$V_{CC} = 2.7 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	4	-	-	-	Ω
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V};$ $I_{SW} = 1000 \mu\text{A}$		-	4	-	-	-	Ω
		$V_{CC} = 4.5 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	3	-	-	-	Ω
		$V_{CC} = 6.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	2	-	-	-	Ω

#### Triple single-pole double-throw analog switch

**Table 7.** ON resistance ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see <u>Figure 11</u> and Figure 12.

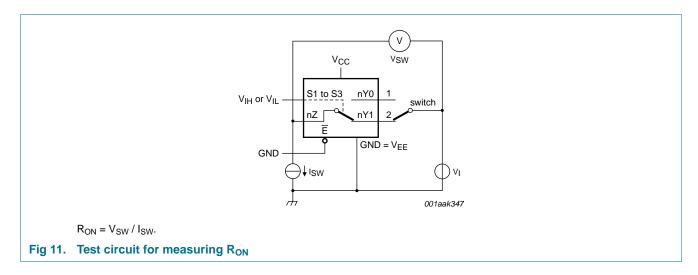
Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
R <sub>ON(rail)</sub>	ON resistance (rail)	$V_I = GND$							
		$V_{CC} = 1.2 \text{ V}; I_{SW} = 100 \mu\text{A}$	[2]	-	250	-	-	-	Ω
		$V_{CC} = 2.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	120	280	-	325	Ω
		$V_{CC} = 2.7 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	75	170	-	195	Ω
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V};$ $I_{SW} = 1000  \mu\text{A}$		-	70	155	-	180	Ω
		$V_{CC} = 4.5 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	50	120	-	135	Ω
		$V_{CC} = 6.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	45	105	-	120	Ω
R <sub>ON(rail)</sub>	ON resistance (rail)	$V_I = V_{CC} - V_{EE}$							
		$V_{CC} = 1.2 \text{ V}; I_{SW} = 100 \mu\text{A}$	[2]	-	350	-	-	-	Ω
		$V_{CC} = 2.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	170	340	-	400	Ω
		$V_{CC} = 2.7 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	105	210	-	250	Ω
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V};$ $I_{SW} = 1000  \mu\text{A}$		-	95	190	-	225	Ω
		$V_{CC} = 4.5 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	70	140	-	165	Ω
		$V_{CC} = 6.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	65	125	-	150	Ω

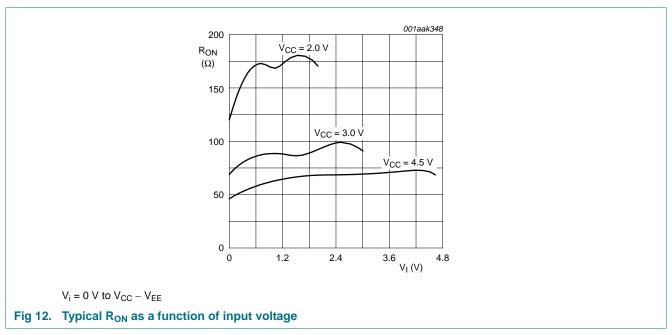
<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C.

<sup>[2]</sup> When supply voltages (V<sub>CC</sub> – V<sub>EE</sub>) near 1.2 V the analog switch ON resistance becomes extremely non-linear. When using a supply of 1.2 V, it is recommended to use these devices only for transmitting digital signals.

#### Triple single-pole double-throw analog switch

#### 9.3 On resistance waveform and test circuit





#### Triple single-pole double-throw analog switch

# 10. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 15.

Symbol	Parameter	Conditions		-40	°C to +85	5 °C	–40 °C t	o +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation delay	nYn, nZ to nZ, nYn; see Figure 13	[2]						
		V <sub>CC</sub> = 1.2 V		-	25	-	-	-	ns
		V <sub>CC</sub> = 2.0 V		-	9	17	-	20	ns
		V <sub>CC</sub> = 2.7 V		-	6	13	-	15	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	[3]	-	5	10	-	12	ns
	V <sub>CC</sub> = 4.5 V		-	4	9	-	10	ns	
		V <sub>CC</sub> = 6.0 V		-	3	7	-	8	ns
t <sub>en</sub> enab	enable time	E to nYn, nZ; see Figure 14	[2]						
		V <sub>CC</sub> = 1.2 V		-	100	-	-	-	ns
		V <sub>CC</sub> = 2.0 V		-	34	65	-	77	ns
		V <sub>CC</sub> = 2.7 V		-	25	48	-	56	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V; } C_L = 15 \text{ pF}$	[3]	-	16	-	-	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	[3]	-	19	38	-	45	ns
		V <sub>CC</sub> = 4.5 V		-	17	32	-	38	ns
		V <sub>CC</sub> = 6.0 V		-	13	25	-	29	ns
		Sn to nYn, nZ; see Figure 14	[2]						
		V <sub>CC</sub> = 1.2 V		-	125	-	-	-	ns
		V <sub>CC</sub> = 2.0 V		-	43	82	-	97	ns
		V <sub>CC</sub> = 2.7 V		-	31	60	-	71	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V; } C_L = 15 \text{ pF}$	[3]	-	20	-	-	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	[3]	-	24	48	-	57	ns
		V <sub>CC</sub> = 4.5 V		-	21	41	-	48	ns
		V <sub>CC</sub> = 6.0 V		-	16	31	-	37	ns

#### Triple single-pole double-throw analog switch

 Table 8.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 15.

Symbol	Parameter	Conditions		-40	°C to +85	°C	–40 °C t	o +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t <sub>dis</sub>	disable time	E to nYn, nZ; see Figure 14	[2]						
		V <sub>CC</sub> = 1.2 V		-	95	-	-	-	ns
		V <sub>CC</sub> = 2.0 V		-	34	61	-	73	ns
		V <sub>CC</sub> = 2.7 V		-	26	46	-	54	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V; } C_L = 15 \text{ pF}$	[3]	-	17	-	-	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	[3]	-	20	37	-	44	ns
		V <sub>CC</sub> = 4.5 V		-	18	32	-	38	ns
		V <sub>CC</sub> = 6.0 V		-	15	25	-	30	ns
		Sn to nYn, nZ; see Figure 14	[2]						
		V <sub>CC</sub> = 1.2 V		-	90	-	-	-	ns
		V <sub>CC</sub> = 2.0 V		-	32	59	-	70	ns
		V <sub>CC</sub> = 2.7 V		-	24	44	-	52	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V; } C_L = 15 \text{ pF}$	[3]	-	16	-	-	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	[3]	-	19	36	-	42	ns
		V <sub>CC</sub> = 4.5 V		-	17	31	-	36	ns
		V <sub>CC</sub> = 6.0 V		-	14	24	-	28	ns
C <sub>PD</sub>	power dissipation capacitance	$C_L$ = 50 pF; $f_i$ = 1 MHz; $V_I$ = GND to $V_{CC}$	[4]	-	36	-	-	-	pF

- [1] All typical values are measured at  $T_{amb}$  = 25 °C.
- [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
  - $t_{\text{en}}$  is the same as  $t_{\text{PZL}}$  and  $t_{\text{PZH}}.$
  - $t_{\text{dis}}$  is the same as  $t_{\text{PLZ}}$  and  $t_{\text{PHZ}}$ .
- [3] Typical values are measured at nominal supply voltage ( $V_{CC} = 3.3 \text{ V}$ ).
- [4]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

$$P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma ((C_L + C_{SW}) \times V_{CC}{}^2 \times f_o) \text{ where:}$$

 $f_i$  = input frequency in MHz,  $f_o$  = output frequency in MHz

 $C_L$  = output load capacitance in pF

C<sub>SW</sub> = maximum switch capacitance in pF;

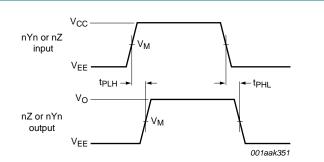
V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

## Triple single-pole double-throw analog switch

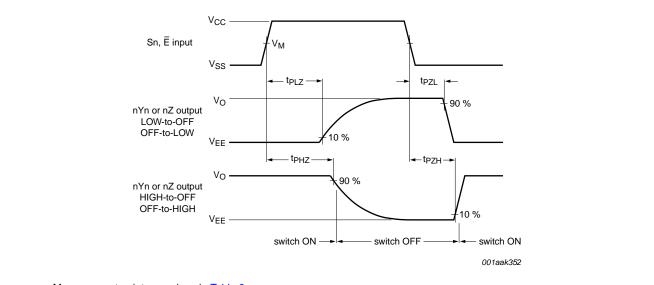
#### 10.1 Waveforms



Measurement points are given in Table 9.

 $V_{\mbox{\scriptsize OL}}$  and  $V_{\mbox{\scriptsize OH}}$  are typical voltage output levels that occur with the output load.

Fig 13. nYn, nZ to nZ, nYn propagation delays



Measurement points are given in Table 9.

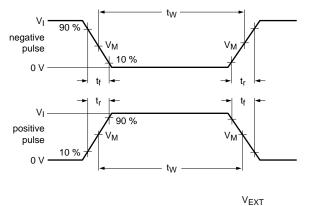
 $\ensuremath{V_{OL}}$  and  $\ensuremath{V_{OH}}$  are typical voltage output levels that occur with the output load.

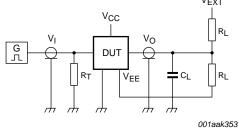
Fig 14. Enable and disable times

Table 9. Measurement points

Supply voltage	Input	Output							
V <sub>CC</sub>	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>					
< 2.7 V	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	V <sub>OL</sub> + 0.1V <sub>CC</sub>	V <sub>OH</sub> – 0.1V <sub>CC</sub>					
2.7 V to 3.6 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> – 0.3 V					
> 3.6 V	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	V <sub>OL</sub> + 0.1V <sub>CC</sub>	V <sub>OH</sub> – 0.1V <sub>CC</sub>					

#### Triple single-pole double-throw analog switch





Test data is given in Table 10.

Definitions for test circuit:

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

 $V_{\text{EXT}}$  = External voltage for measuring switching times.

Fig 15. Test circuit for measuring switching times

Table 10. Test data

Supply voltage	Input		Load		V <sub>EXT</sub>			
V <sub>CC</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>	
< 2.7 V	V <sub>CC</sub>	≤ 6 ns	50 pF	1 kΩ	open	V <sub>EE</sub>	2V <sub>CC</sub>	
2.7 V to 3.6 V	2.7 V	≤ 6 ns	15 pF, 50 pF	1 kΩ	open	V <sub>EE</sub>	2V <sub>CC</sub>	
> 3.6 V	V <sub>CC</sub>	≤ 6 ns	50 pF	1 kΩ	open	V <sub>EE</sub>	2V <sub>CC</sub>	

#### Triple single-pole double-throw analog switch

#### 10.2 Additional dynamic parameters

#### Table 11. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V);  $V_I = \text{GND}$  or  $V_{CC}$  (unless otherwise specified);  $t_r = t_f \le 6.0$  ns;  $T_{amb} = 25$  °C.

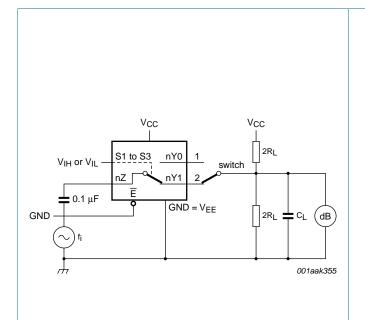
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
THD	total harmonic	$f_i$ = 1 kHz; $C_L$ = 50 pF; $R_L$ = 10 kΩ; see <u>Figure 20</u>					
	distortion	V <sub>CC</sub> = 3.0 V; V <sub>I</sub> = 2.75 V (p-p)		-	8.0	-	%
		V <sub>CC</sub> = 6.0 V; V <sub>I</sub> = 5.5 V (p-p)		-	0.4	-	%
		$f_i$ = 10 kHz; $C_L$ = 50 pF; $R_L$ = 10 k $\Omega$ ; see Figure 20					
		V <sub>CC</sub> = 3.0 V; V <sub>I</sub> = 2.75 V (p-p)		-	2.4	-	%
		V <sub>CC</sub> = 6.0 V; V <sub>I</sub> = 5.5 V (p-p)		-	1.2	-	%
f <sub>(-3dB)</sub>	-3 dB frequency	$C_L = 50 \text{ pF}$ ; $R_L = 50 \Omega$ ; see Figure 16	<u>[1]</u>				
	response	V <sub>CC</sub> = 3.0 V		-	180	-	MHz
		V <sub>CC</sub> = 6.0 V		-	200	-	MHz
$\alpha_{iso}$	isolation (OFF-state)	$f_i$ = 1 MHz; $C_L$ = 50 pF; $R_L$ = 600 $\Omega$ ; see Figure 18	[2]				
		V <sub>CC</sub> = 3.0 V		-	-50	-	dB
		V <sub>CC</sub> = 6.0 V		-	-50	-	dB
V <sub>ct</sub>	crosstalk voltage	between digital inputs and switch; $f_i = 1 \text{ MHz}$ ; $C_L = 50 \text{ pF}$ ; $R_L = 600 \Omega$ ; see Figure 21	[2]				
		V <sub>CC</sub> = 3.0 V		-	0.11	-	V
		V <sub>CC</sub> = 6.0 V		-	0.12	-	V
Xtalk	crosstalk	between switches; $f_i$ = 1 MHz; $C_L$ = 50 pF; $R_L$ = 600 $\Omega$ ; see Figure 22					
		V <sub>CC</sub> = 3.0 V		-	-60	-	dB
		V <sub>CC</sub> = 6.0 V		-	-60	-	dB

<sup>[1]</sup> Adjust  $f_i$  voltage to obtain 0 dBm level at output for 1 MHz (0 dBm = 1 mW into 50  $\Omega$ ).

<sup>[2]</sup> Adjust  $f_i$  voltage to obtain 0 dBm level at output for 1 MHz (0 dBm = 1 mW into 600  $\Omega$ ).

#### Triple single-pole double-throw analog switch

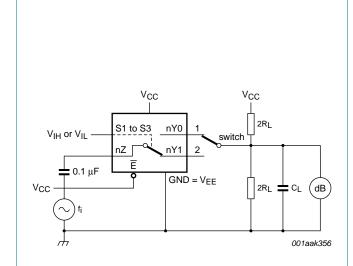
#### 10.2.1 Test circuits



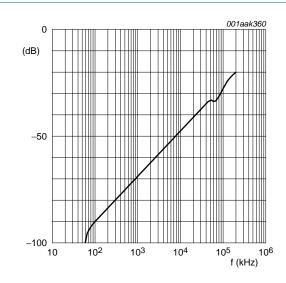
 $V_{CC}$  = 3.0 V; GND = 0 V;  $V_{EE}$  = -3.0 V;  $R_L$  = 50  $\Omega$  R<sub>SOURCE</sub> = 1 k $\Omega$ .

Fig 16. Test circuit for measuring frequency response

Fig 17. Typical frequency response





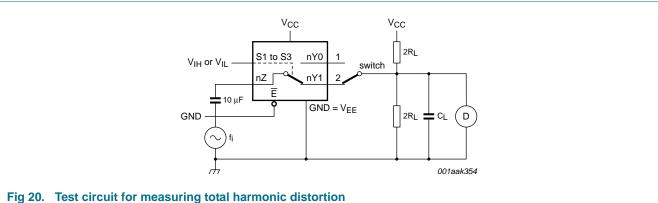


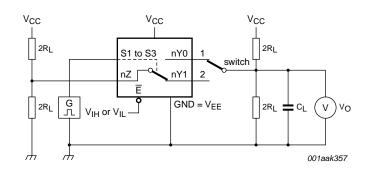
 $V_{CC}$  = 3.0 V; GND = 0 V;  $V_{EE}$  = -3.0 V;  $R_L$  = 50  $\Omega$ ;  $R_{SOURCE}$  = 1 k $\Omega$ .

Fig 19. Typical isolation (OFF-state) as function of frequency

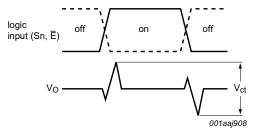
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#### Triple single-pole double-throw analog switch





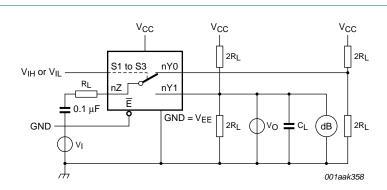
a. Test circuit



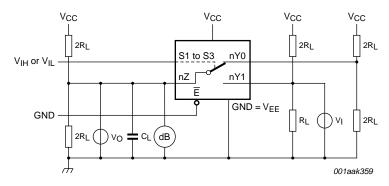
b. Input and output pulse definitions  $V_I$  may be connected to Sn or  $\overline{E}$ .

Fig 21. Test circuit for measuring crosstalk voltage between digital inputs and switch

#### Triple single-pole double-throw analog switch



a. Switch closed condition



b. Switch open condition

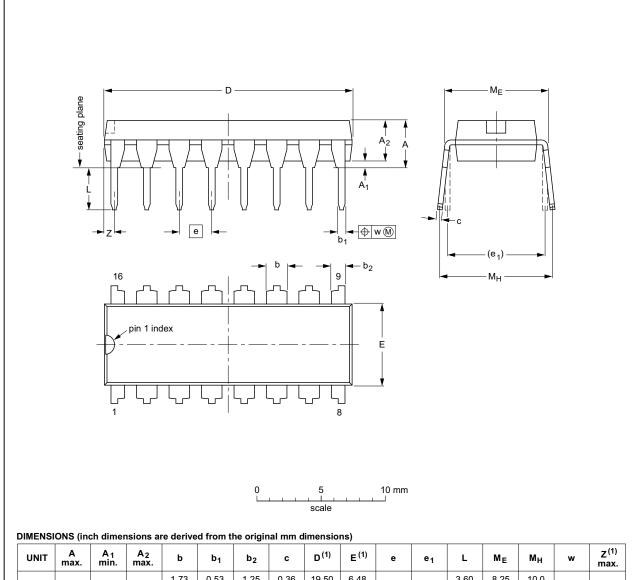
Fig 22. Test circuit for measuring crosstalk between switches

#### Triple single-pole double-throw analog switch

# 11. Package outline

#### DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	b <sub>2</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	ME	Мн	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.02	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.1	0.3	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.03

#### Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

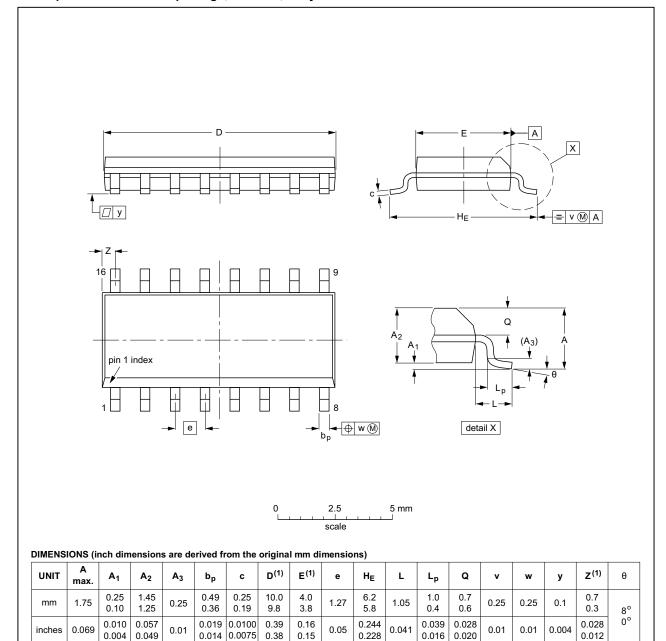
OUTLINE		REFER	EUROPEAN ISSUE DATE PROJECTION 95-01-14					
VERSION	IEC	IEC JEDEC J	JEITA		PROJECTION	ISSUE DATE		
SOT38-4						<del>95-01-14</del> 03-02-13		

Fig 23. Package outline SOT38-4 (DIP16)

#### Triple single-pole double-throw analog switch

#### SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



Note
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN ISSUE DATE			
VERSION	IEC	JEDEC	JEITA	PROJECTION ISSUE DATE			
SOT109-1	076E07	MS-012			<del>99-12-27</del> 03-02-19		

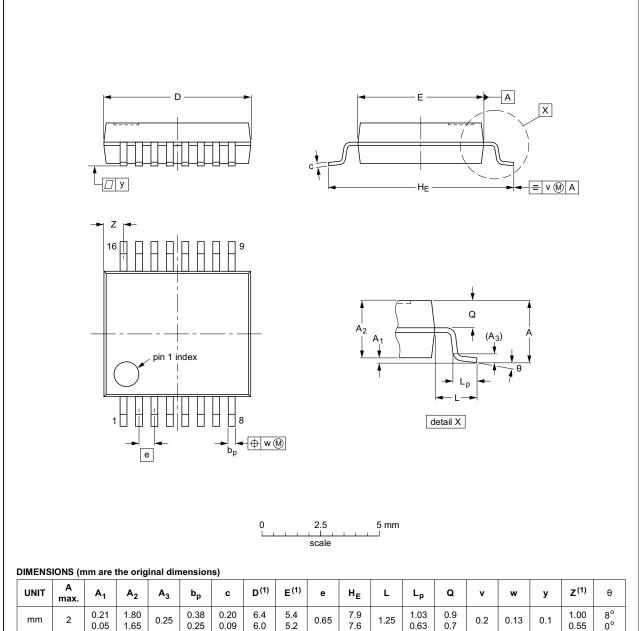
Fig 24. Package outline SOT109-1 (SO16)

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#### Triple single-pole double-throw analog switch

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	<b>A</b> <sub>3</sub>	b <sub>p</sub>	C	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

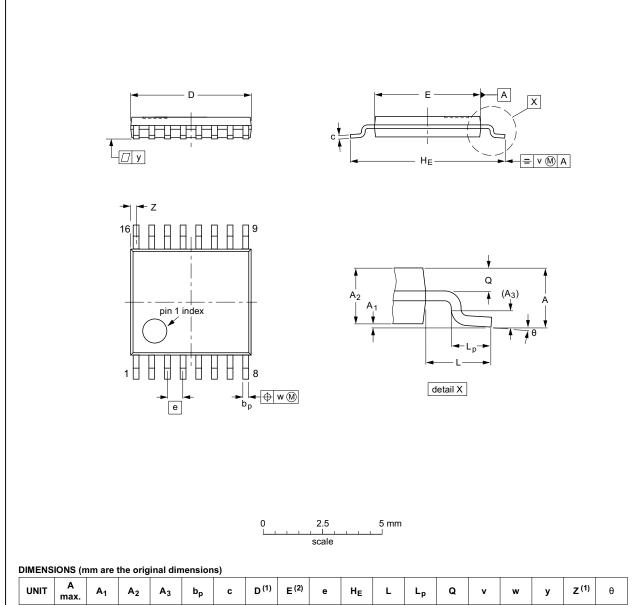
OUTLINE		REFER	EUROPEAN ISSUE DATE  99-12-27 03-02-19			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT338-1		MO-150				<del>99-12-27</del> 03-02-19

Fig 25. Package outline SOT338-1 (SSOP16)

#### Triple single-pole double-throw analog switch

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	<b>A</b> <sub>3</sub>	bp	С	D <sup>(1)</sup>	E (2)	е	HE	L	Lp	Q	٧	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

F		REFERENCE	EUROPEAN PROJECTION ISSUE DATE				
JEDEC	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
MO-153		MO-153				<del>99-12-27</del> 03-02-18	
MO-153		MO-153					

Fig 26. Package outline SOT403-1 (TSSOP16)

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#### Triple single-pole double-throw analog switch

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

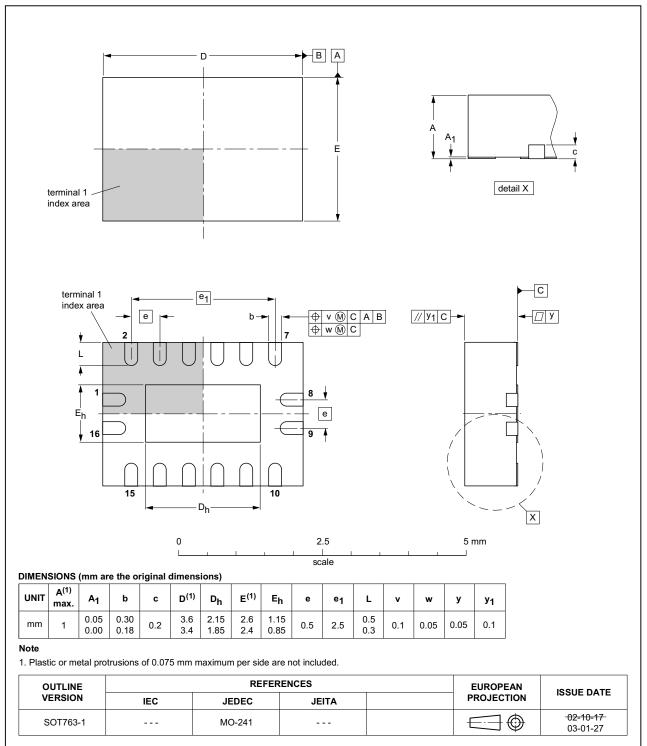


Fig 27. Package outline SOT763-1 (DHVQFN16)

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## Triple single-pole double-throw analog switch

# 12. Abbreviations

#### Table 12. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

# 13. Revision history

#### Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LV4053 v.5	20140918	Product data sheet	-	74LV4053 v.4
Modifications:	• Figure 7: Figu	re note added for DHVQFN16	package.	
74LV4053 v.4	20090810	Product data sheet	-	74LV4053 v.3
Modifications:	guidelines of l Legal texts ha Added type no Ron values ch	this data sheet has been rede NXP Semiconductors. we been adapted to the new c umber 74LV4053BQ (DHVQFN nanged in Section 2.	ompany name where	e appropriate.
	<ul> <li>Package vers</li> </ul>	ion SOT38-1 changed to SOT	38-4 in <u>Section 3</u> , ar	id <u>Figure 23</u> .
74LV4053 v.3	19980623	Product specification	-	74LV4053 v.2
74LV4053 v.2	19970715	Product specification	-	-

#### Triple single-pole double-throw analog switch

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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#### Triple single-pole double-throw analog switch

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